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(12) **United States Design Patent**
Gerdom

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(54) **PAIR OF HOUSINGS FOR BONE VIBRATING AUDIO TRANSDUCERS FOR A COMMUNICATIONS HEADSET**

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(73) **Assignee:** **Atlantic Signal Corporation, Overland Park, KS (US)**

(**) **Term:** **14 Years**

(21) **Appl. No.:** **29/137,170**

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Related U.S. Application Data

(60) Continuation-in-part of application No. 29/134,037, filed on Dec. 12, 2000, which is a division of application No. 29/118,637, filed on Feb. 11, 2000, now Pat. No. Des. 444,142, which is a division of application No. 29/092,211, filed on Aug. 14, 1998, now Pat. No. Des. 424,568.

(51) **LOC (7) Cl.** **14-01**

(52) **U.S. Cl.** **D14/223; D14/222**

(58) **Field of Search** **D14/192, 205, D14/206, 222-224; 181/129, 132; 381/150, 151, 337, 377**

(56) **References Cited**

U.S. PATENT DOCUMENTS

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OTHER PUBLICATIONS

Radio Headsets brochure of Telex, 8601 East Cornhusker Highway, Lincoln, NE 68507, exact publication date unknown but headsets shown therein were distributed prior to invention by applicant of claimed ornamental design. Operating Instructions manual for New Eagle Low Profile Headset showing headsets distributed prior to invention by applicant of claimed ornamental design.

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(57) **CLAIM**

The ornamental design for pair of housings for bone vibrating audio transducers for a communications headset, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of pair of housings for bone vibrating audio transducers for a communications headset showing my new design, the broken line showing of the headbands, microphone and cord is for illustrative purposes only and forms no part of the claimed design.

FIG. 2 is an enlarged left side elevational view of the left side housing thereof, shown separately for clarity of illustration;

FIG. 3 is a right side elevational view thereof;

FIG. 4 is a front elevational view thereof;

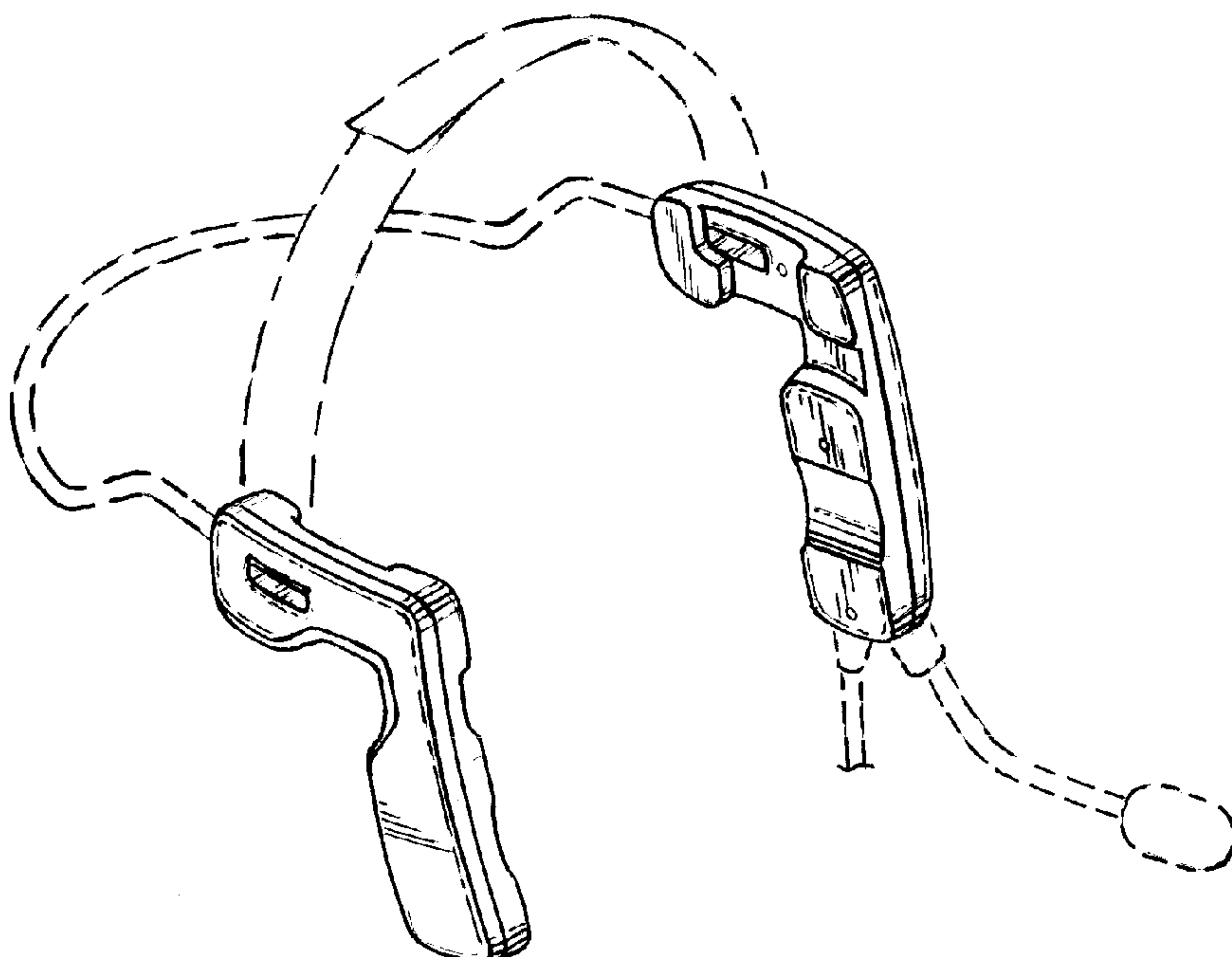
FIG. 5 is a rear elevational view thereof;

FIG. 6 is a top plan view thereof; and,

FIG. 7 is a bottom plan view thereof.

The undisclosed views of the right side housing are mirror images of the left side views.

1 Claim, 2 Drawing Sheets



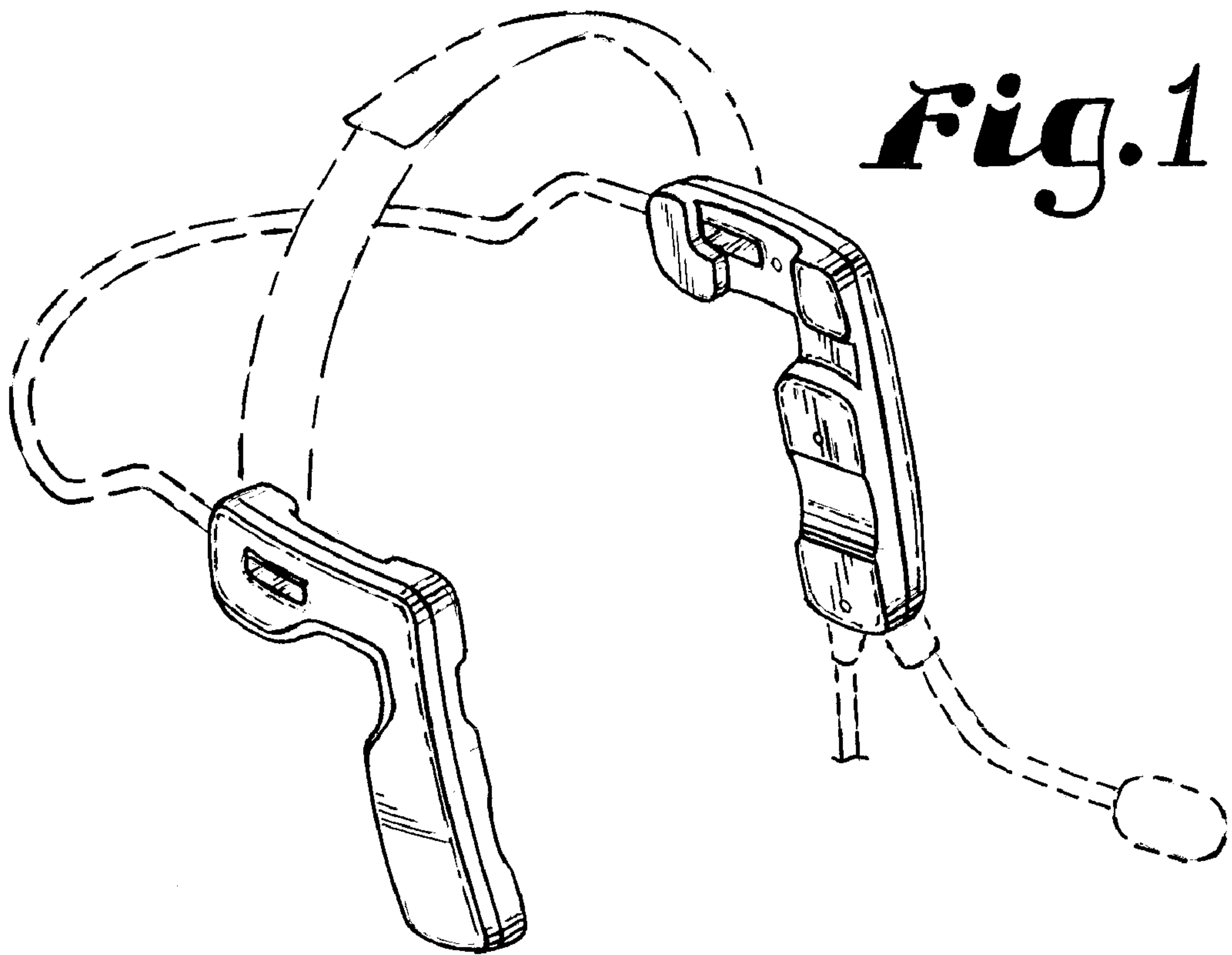


Fig. 1.

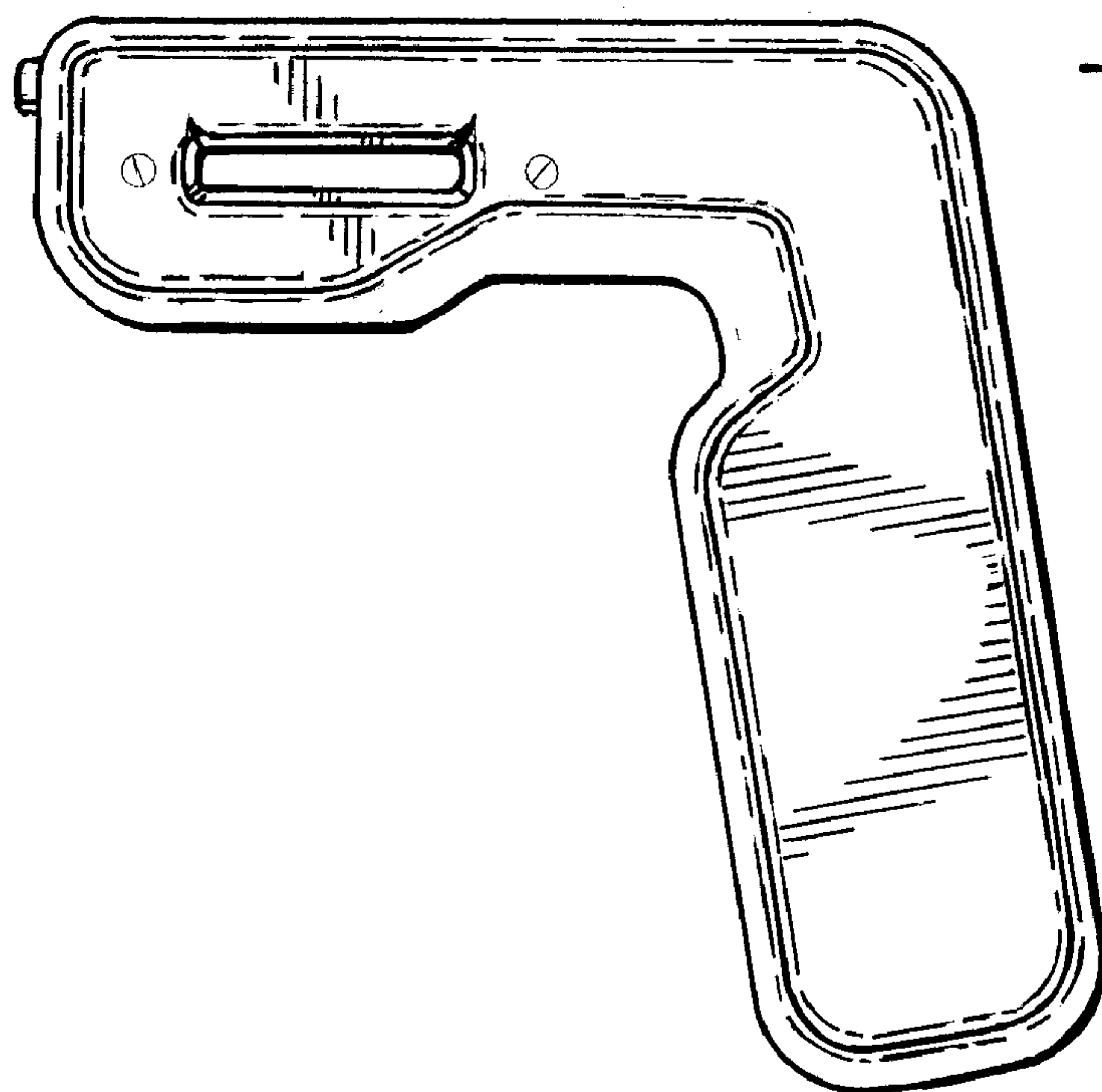


Fig. 2.

Fig. 6.

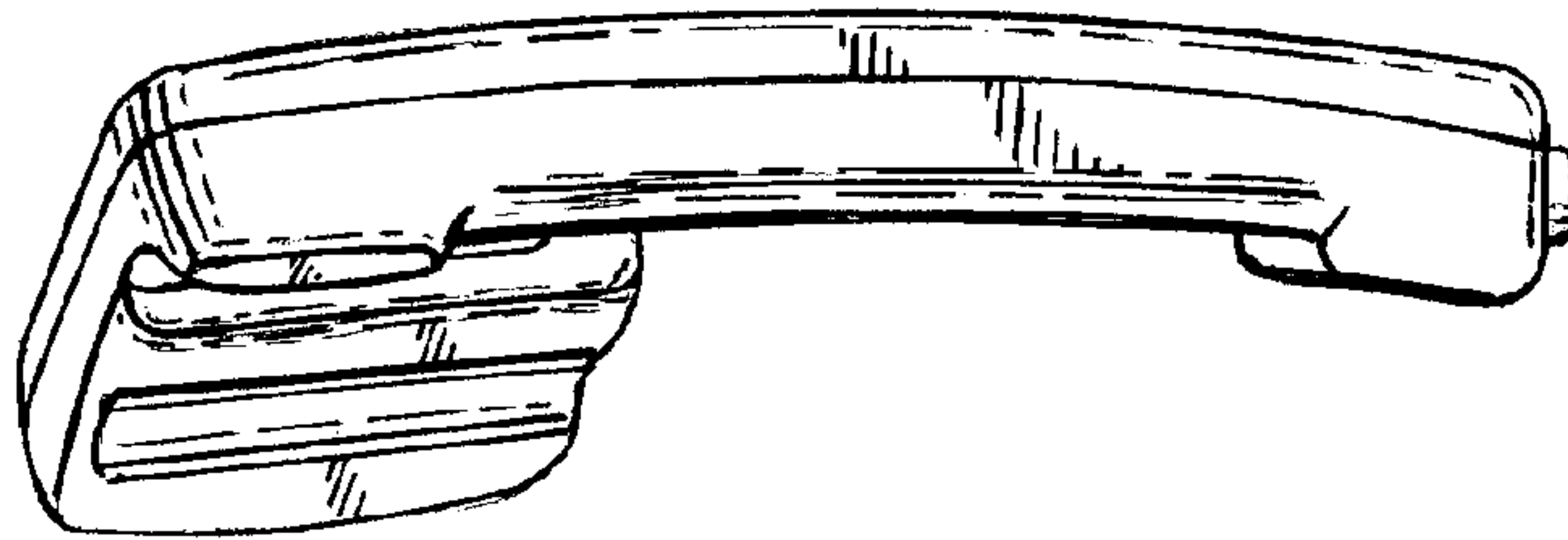


Fig. 4.



Fig. 5.

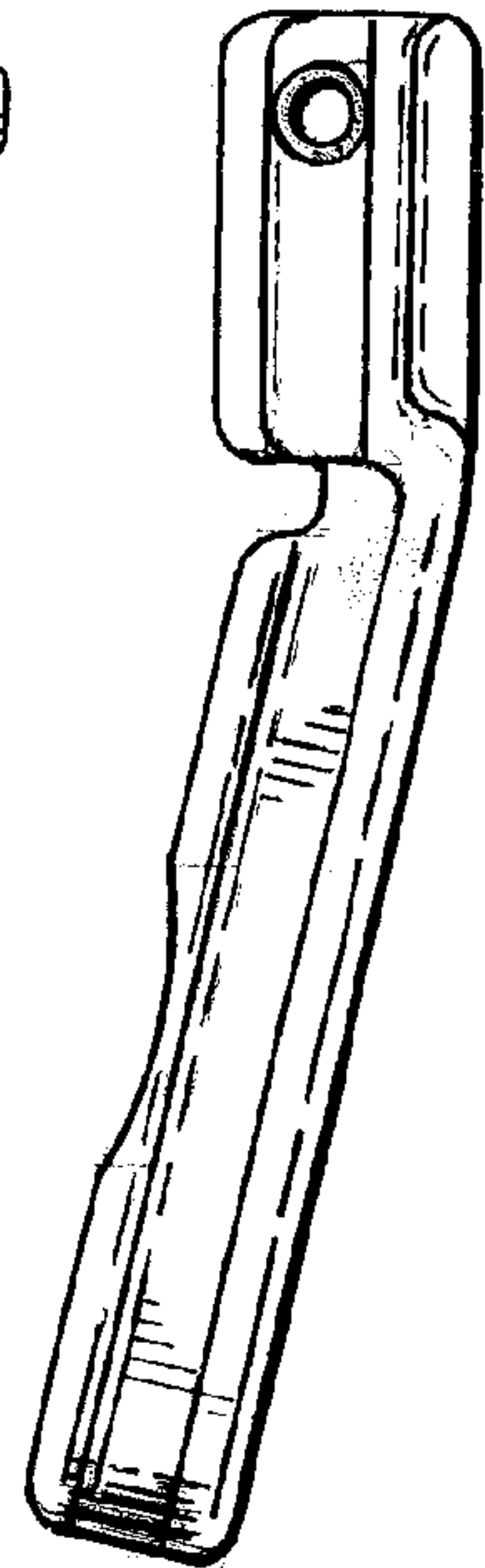


Fig. 3.

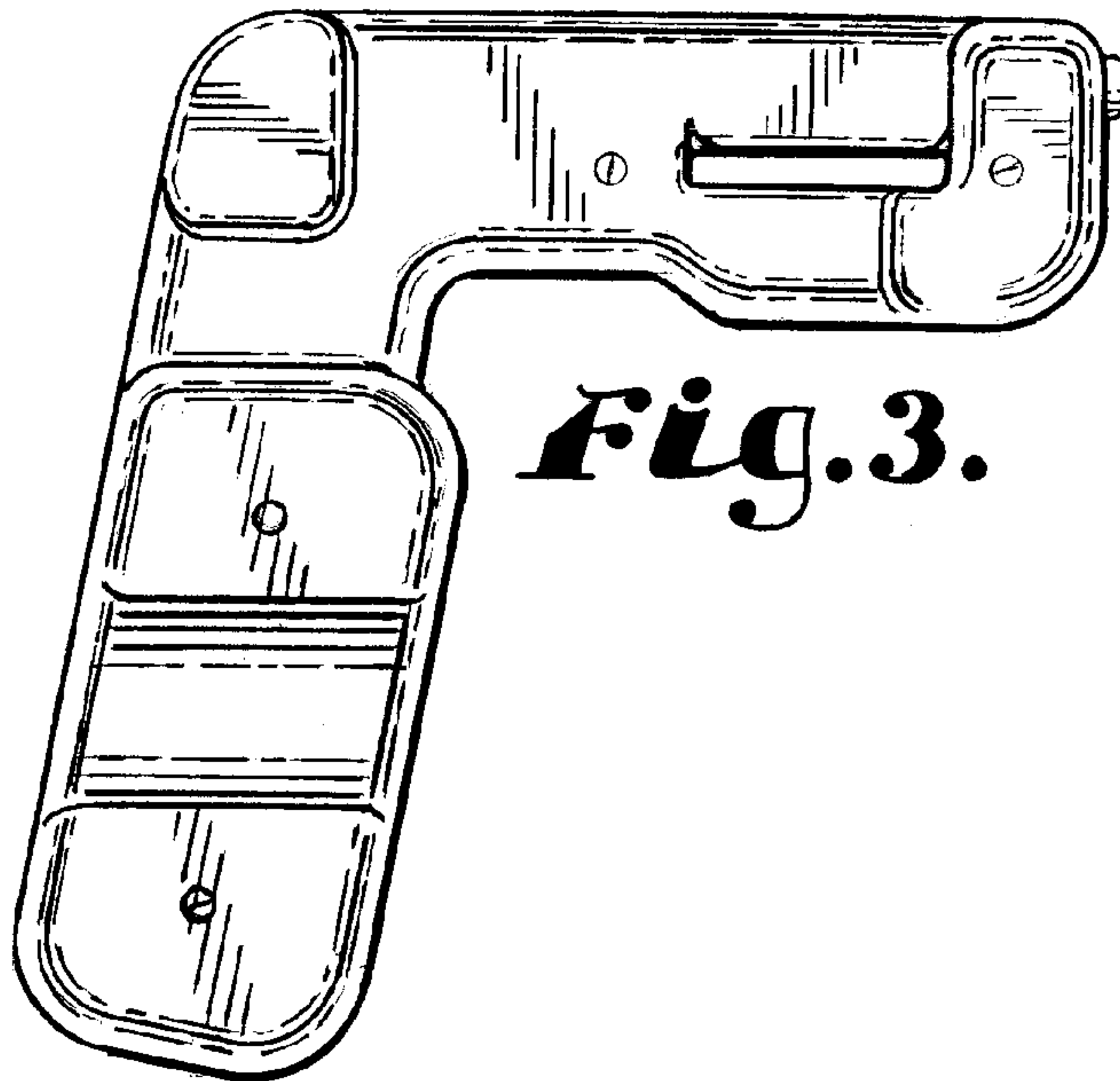


Fig. 7.

